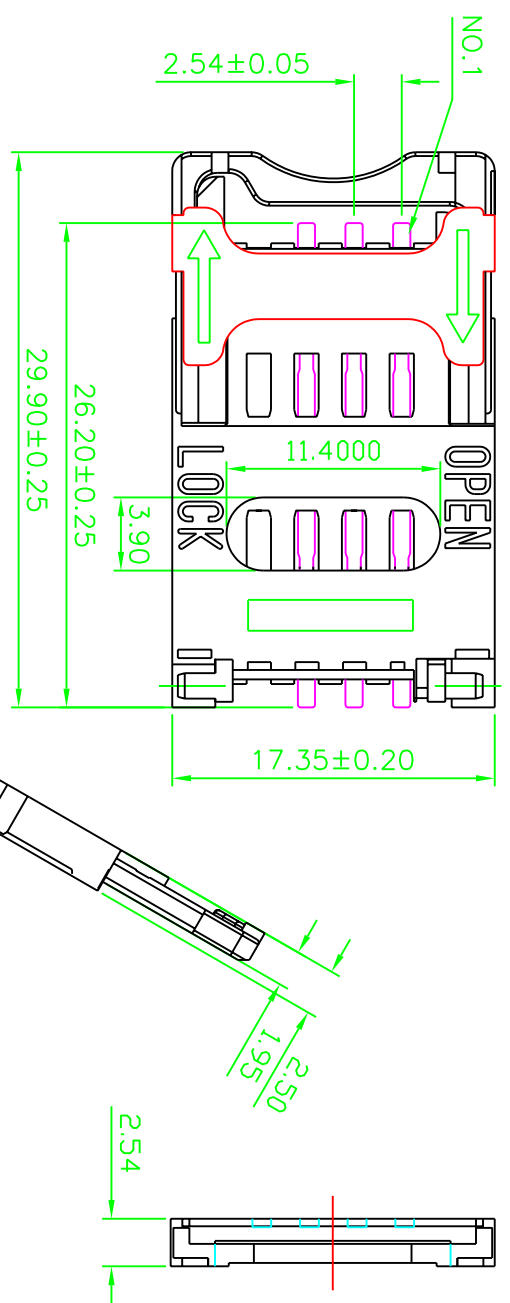
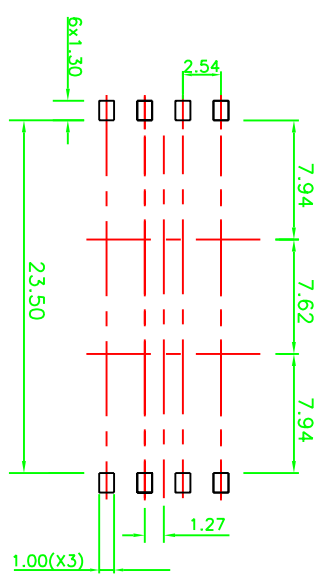
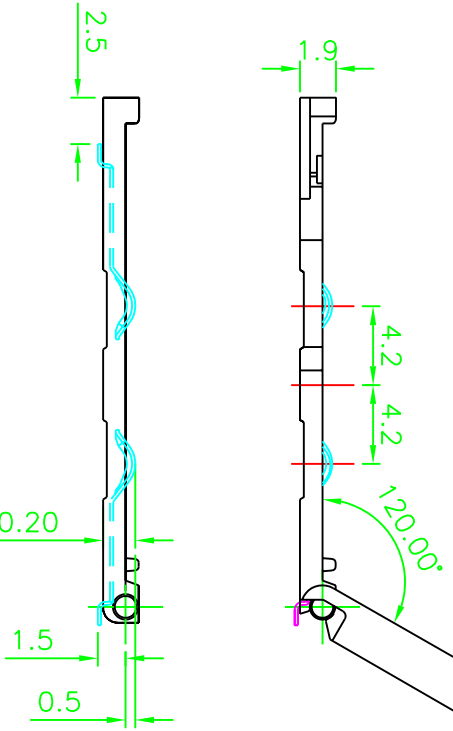


REV.	DESCRIPTION	DATE



**Specifications**  
 Current Rating: 1Amp  
 Insulation Resistance:  $10^3$  M ohms  
 Dielectric Withstanding: 250VAC  
 Contact Resistance: 100m ohms.  
 Operating Temperature: -40°C to +85°C  
 Max Process Temp: 200°C for 20~30 sec.  
 (230°C for 10-15seconds)

**Materials**  
 Contact Material: Phosphor Bronze  
 Insulation Material: Polyester, UL 94V-0  
 Nylon 6T  
 All materials must be GP materials



RECOMMENDED P.C. BOARD LAYOUT

格 菱 股 份 有 限 公 司 <b>Greenconn Corporation</b>		<b>GENERAL TOLERANCE</b> X. <sup>°</sup> ± 5° X. ± .X <sup>°</sup> ± 2° X ± 0.38 .XX <sup>°</sup> ± 1° .XX ± 0.25 .XXX <sup>°</sup> ± 0.5° .XXX ± 0.13		<b>DESIGN:</b> XIAO PING <b>DATE:</b> 04-15-05		<b>DWG. NO.</b> G ZN025-10		<b>TITLE.</b> SIM CARD 組合圖	
REV.	01	UNIT.	mm	SCALE:	2.5:1	CHECKED:	DATE:	PART NO.	G ZN025-100
						AUDITED:	DATE:		
						APPROVED:	DATE:		